

SBR2U30P1

2.0A SBR[®] Super Barrier Rectifier PowerDI[™]123

Features Mechanical Data

- Ultra Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented Interlocking Clip Design for High Surge Current Capacity
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- ±16KV ESD Protection (HBM, 3B)
- ±25KV ESD Protection (IEC61000-4-2 Level 4, Air Discharge)
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q 101 Standards for High Reliability

- Case: PowerDI™123
- Case Material: Molded Plastic, "Green" Molding compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Polarity Indicator: Cathode Band
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Marking Information: See Page 4
- Ordering Information: See Page 4

Maximum Ratings @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	30	V	
RMS Reverse Voltage	$V_{R(RMS)}$	21	V	
Average Rectified Output Current (See Figure 1)	Io	2.0	A	
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	75	А	
Non-Repetitive Avalanche Energy $(T_J = 25^{\circ}C, I_{AS} = 5A, L = 8.5 \text{ mH})$	E _{AS}	105	mJ	
Repetitive Peak Avalanche Energy $(T_P = 1\mu s, T_j = 25^{\circ}C)$	P _{ARM}	1100	W	
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 2) Thermal Resistance Junction to Ambient (Note 3) Thermal Resistance Junction to Ambient (Note 4)	R _{OJS} R _{OJA}	5 178 123	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C	

Notes:

- 1. RoHS revision 13.2.2003. High temperature solder exemption applied, see *EU Directive Annex Note* 7.
- 2. Theoretical R_{OJS} calculated from the top center of the die straight down to the PCB cathode tab solder junction.
- 3. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
- 4. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf

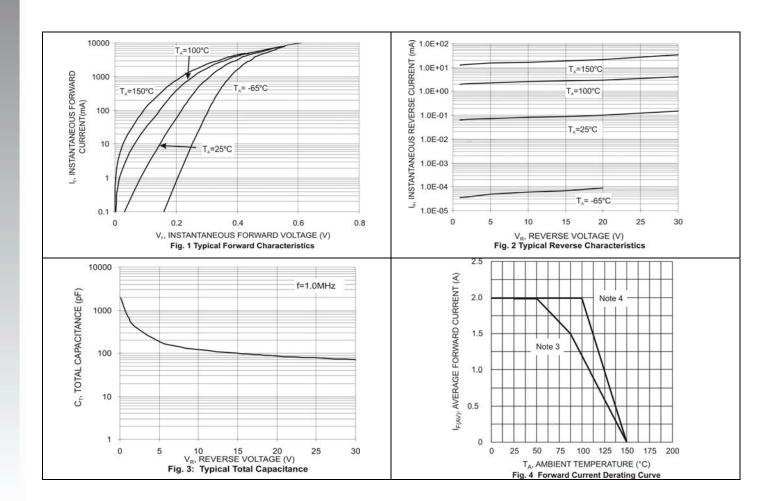


Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	30	-	-	V	I _R = 400 μA
		-	0.22	0.26		$I_F = 0.1A, T_J = 25^{\circ}C$
			0.31	0.35	V	$I_F = 1.0A, T_J = 25^{\circ}C$
Forward Valtage Dran	.,		0.36	0.40		$I_F = 2.0A, T_J = 25^{\circ}C$
Forward Voltage Drop	V _F		0.12	0.15		$I_F = 0.1A, T_J = 125^{\circ}C$
			0.27	0.30		$I_F = 1.0A, T_J = 125^{\circ}C$
			0.30	0.33		$I_F = 2.0A, T_J = 125^{\circ}C$
	I _R	-	75	150	μA	V _R = 5V, T _J = 25 °C
Lookaga Current (Note E)			150	400	μA	$V_R = 30V, T_J = 25 {}^{\circ}C$
Leakage Current (Note 5)			6	15	mA	V _R = 5V, T _J = 125 °C
			12	20	mA	$V_R = 30V, T_J = 125 {}^{\circ}\text{C}$

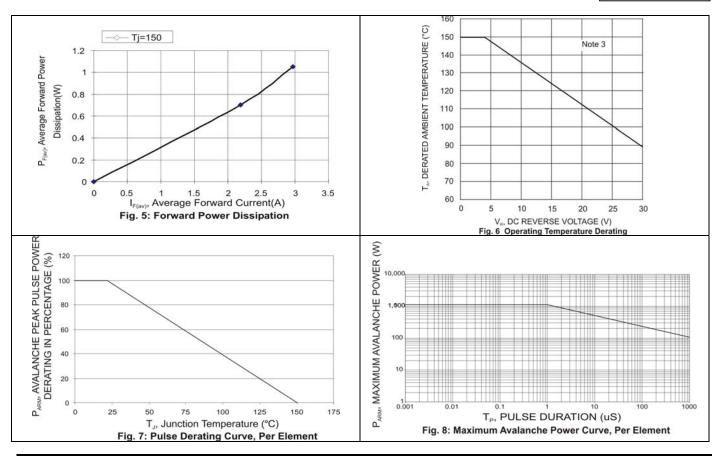
Notes:

5. Short duration pulse test used to minimize self-heating effect.



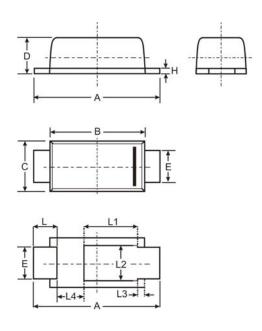


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Package Outline Drawings

PowerDI™123



PowerDI [™] 123									
Dim	Min	Max	Тур						
Α	3.65	3.75	3.70						
В	2.775	2.825	2.80						
С	1.750	1.800	1.775						
D	0.955	1.000	0.98						
Е	0.95	1.05	1.00						
Н	0.15	0.25	0.20						
L	0.60	0.70	0.65						
L1	L1 —		1.36						
L2	L2 —		1.10						
L3	_	_	0.20						
L4	0.95	1.25	1.05						
All Dimensions in mm									



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Marking, Polarity, Weight & Ordering Information

_	Case	Style	Marking	Weight		
SBR2U30P	Top View Back View		[2 U3 ₹	0.096g (approx.)		

Ordering Information	Date Code
SBR2U30P1-7 3000/Tape & Reel	2U3 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

Date Code Key

Year	2006		2007		2008		2009		2010	2	011	20	12	
Code	Т		U		V		W		X		Y		Z	
N	Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec	
	Code	1	2	3	4	5	6	7	8	9	0	N	D	

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